BD241C (NPN), BD242B (PNP), BD242C (PNP)

Complementary Silicon Plastic Power Transistors

Designed for use in general purpose amplifier and switching applications.

Features

- High Current Gain − Bandwidth Product
- Compact TO−220 AB Package
- Epoxy Meets UL94 V−0 @ 0.125 in
- These Devices are Pb−Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	BD242B	BD241C BD242C	Unit
Collector−Emitter Voltage	V_{CEO}	80	100	Vdc
Collector−Emitter Voltage	V_{CES}	90	115	Vdc
Emitter−Base Voltage	V_{EB}	5.0		Vdc
Collector Current −Continuous	I_C	3.0		Adc
Collector Current − Peak	I_{CM}	5.0		Adc
Base Current	I_B	1.0		Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	40 0.32		W W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−65 to +150		°C
ESD − Human Body Model	HBM	3B		V
ESD − Machine Model	MM	C		V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	3.125	°C/W

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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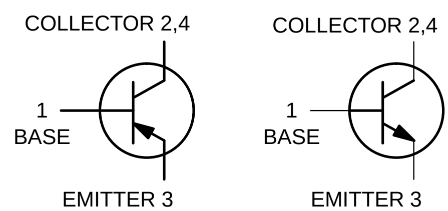
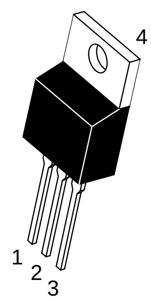
POWER TRANSISTORS COMPLEMENTARY SILICON 3 AMP 80−100 VOLTS 40 WATTS

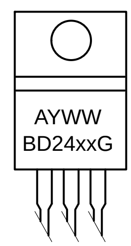
COMPLEMENTARY





TO−220 CASE 221A STYLE 1

MARKING DIAGRAM



BD24xx = Device Code
xx = 1C, 2B, or 2C
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

ORDERING INFORMATION

Device	Package	Shipping†
BD241CG	TO−220 (Pb−Free)	50 Units/Rail
BD242BG	TO−220 (Pb−Free)	50 Units/Rail
BD242CG	TO−220 (Pb−Free)	50 Units/Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector−Emitter Sustaining Voltage (Note 1) (I_C = 30 mAdc, I_B = 0)	 BD242B BD241C, BD242C	V_{CEO}	 80 100		Vdc
Collector Cutoff Current (V_{CE} = 50 Vdc, I_B = 0) (V_{CE} = 60 Vdc, I_B = 0)	 BD242B BD241C, BD242C	I_{CEO}		 0.3	mAdc
Collector Cutoff Current (V_{CE} = 80 Vdc, V_{EB} = 0) (V_{CE} = 100 Vdc, V_{EB} = 0)	 BD242B BD241C, BD242C	I_{CES}		 200	μAdc
Emitter Cutoff Current (V_{BE} = 5.0 Vdc, I_C = 0)		I_{EBO}		1.0	mAdc
ON CHARACTERISTICS (Note 1)					
DC Current Gain (I_C = 1.0 Adc, V_{CE} = 4.0 Vdc) (I_C = 3.0 Adc, V_{CE} = 4.0 Vdc)		h_{FE}	 25 10		
Collector−Emitter Saturation Voltage (I_C = 3.0 Adc, I_B = 0.6 Adc)		$V_{CE(sat)}$		1.2	Vdc
Base−Emitter On Voltage (I_C = 3.0 Adc, V_{CE} = 4.0 Vdc)		$V_{BE(on)}$		1.8	Vdc
DYNAMIC CHARACTERISTICS					
Current Gain − Bandwidth Product (Note 2) (I_C = 500 mAdc, V_{CE} = 10 Vdc, f_{test} = 1.0 MHz)		f_T	3.0		MHz
Small−Signal Current Gain (I_C = 0.5 Adc, V_{CE} = 10 Vdc, f = 1.0 kHz)		h_{fe}	20		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.
2. $f_T = |h_{fe}| \bullet f_{test}$.

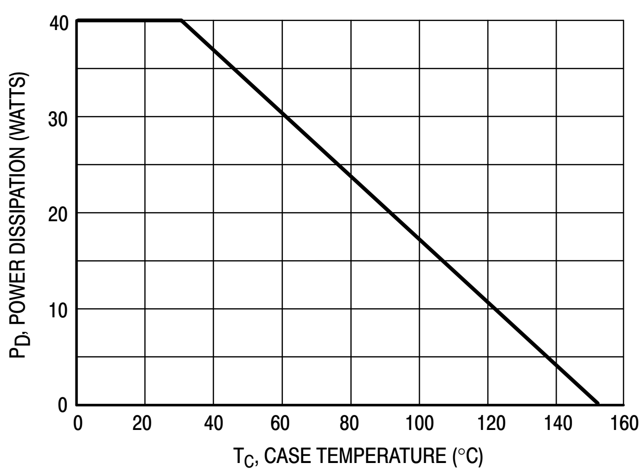


Figure 1. Power Derating

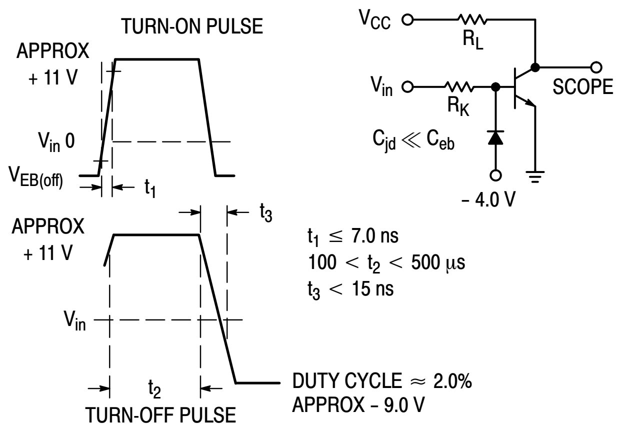


Figure 2. Switching Time Equivalent Circuit

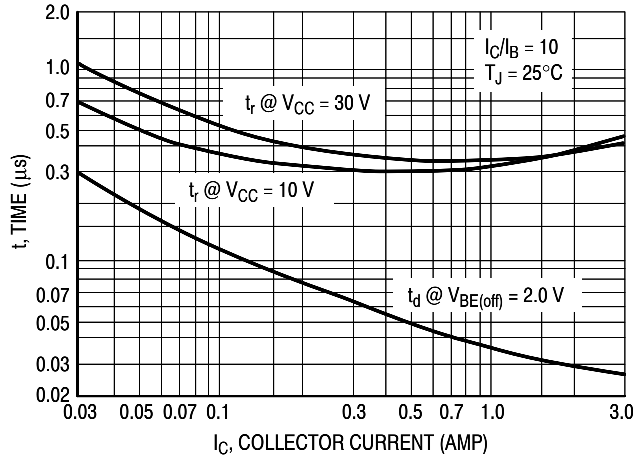


Figure 3. Turn−On Time

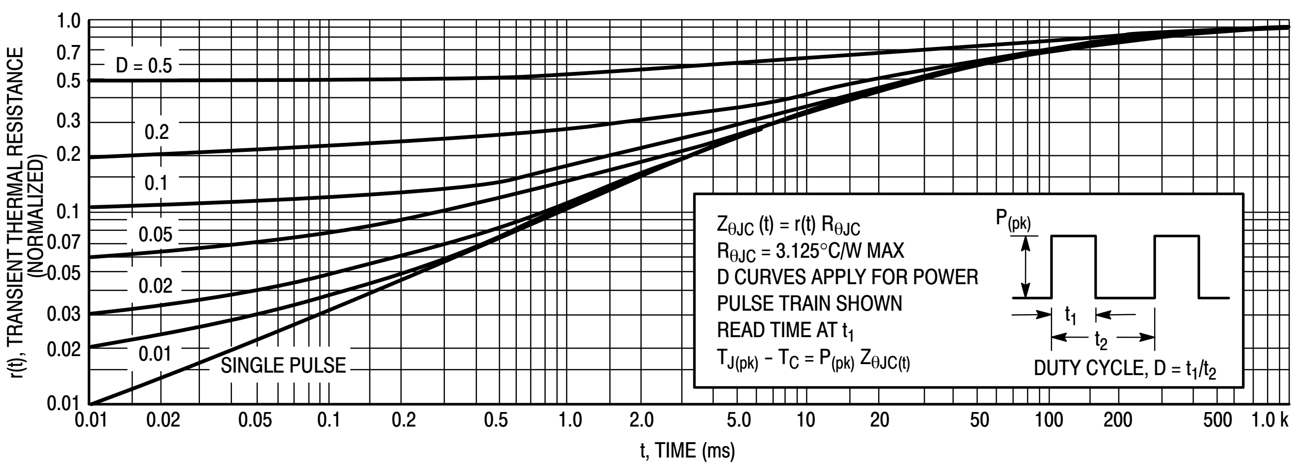


Figure 4. Thermal Response

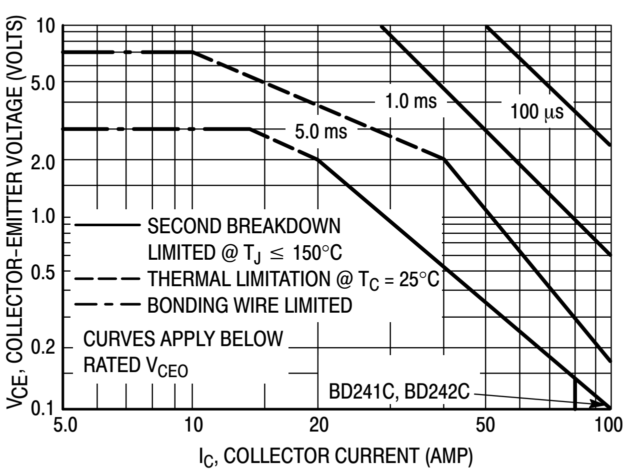


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150°C$; T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150°C$, $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

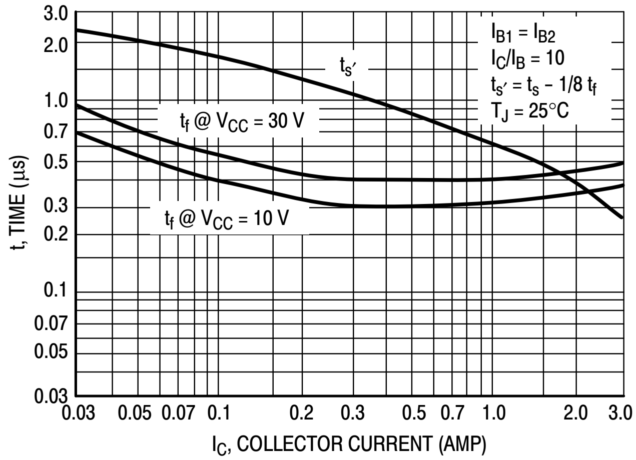


Figure 6. Turn−Off Time

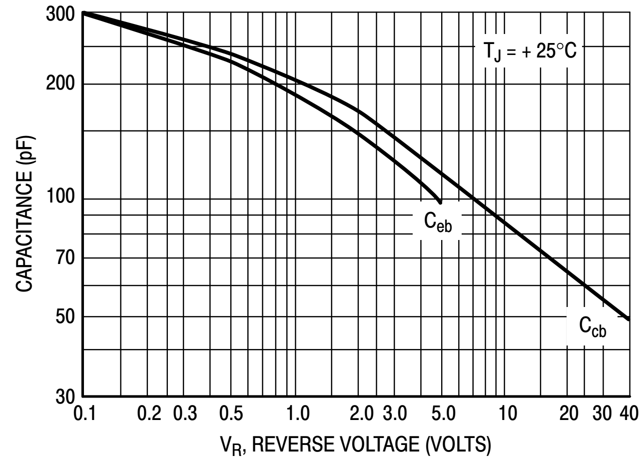


Figure 7. Capacitance

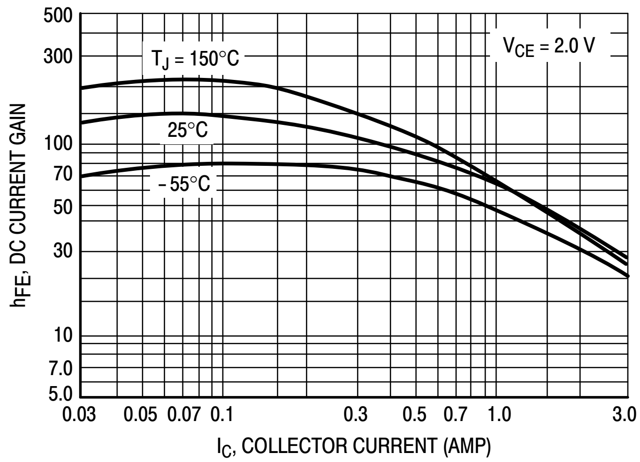


Figure 8. DC Current Gain

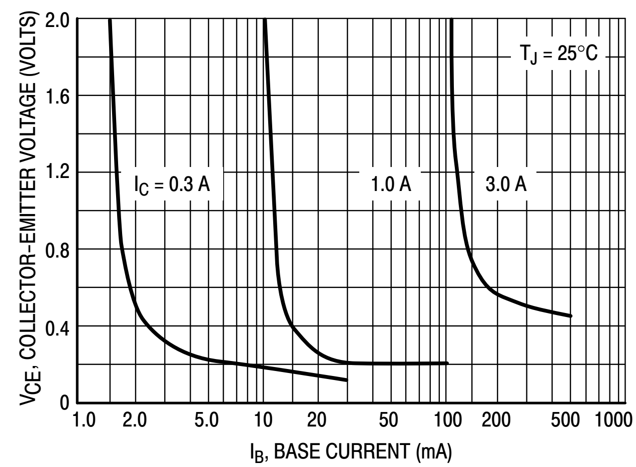


Figure 9. Collector Saturation Region

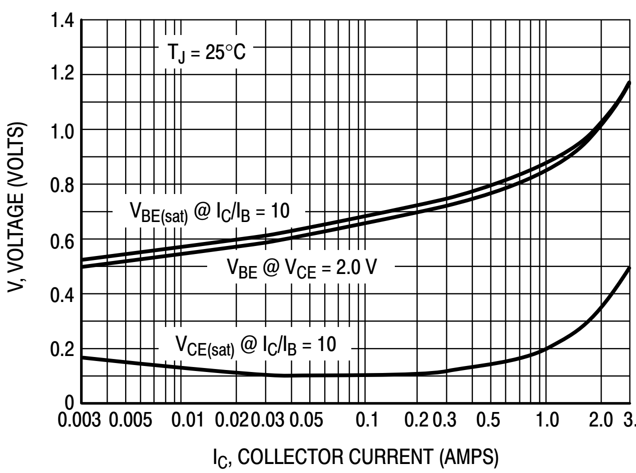


Figure 10. “On” Voltages

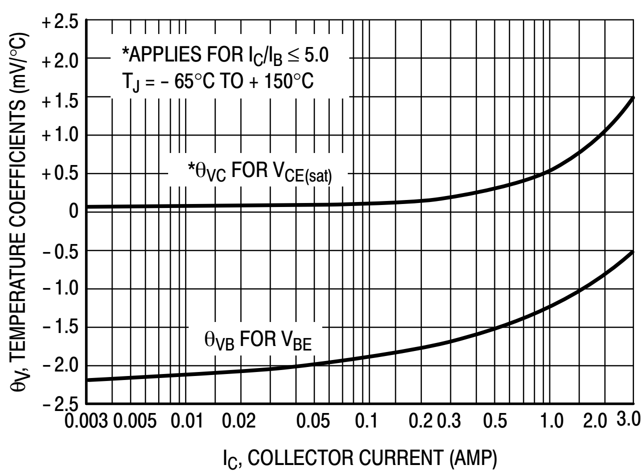


Figure 11. Temperature Coefficients

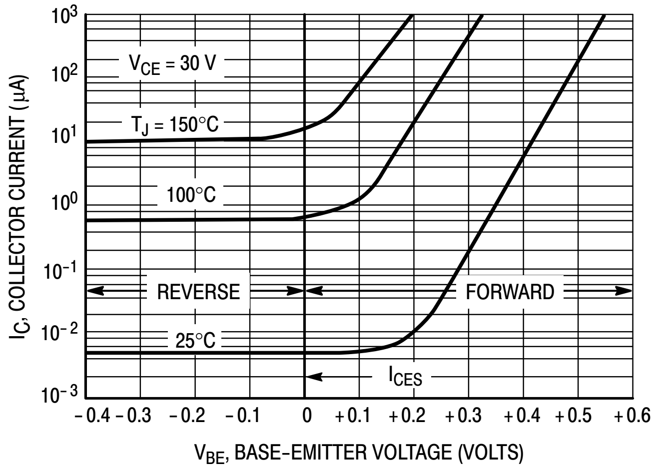


Figure 12. Collector Cut−Off Region

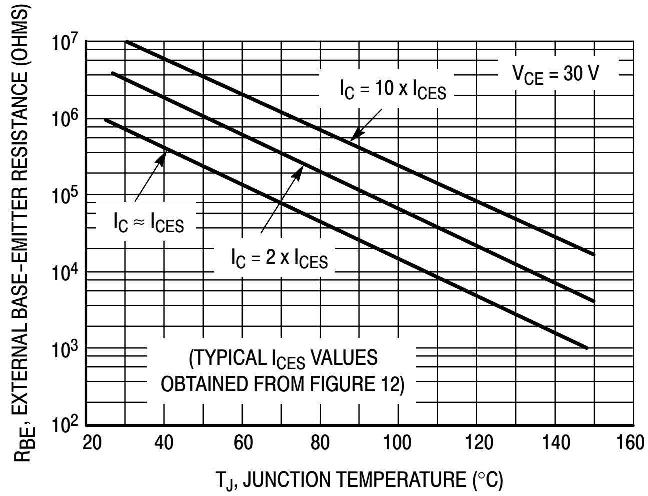


Figure 13. Effects of Base−Emitter Resistance

ADDITIONAL INFORMATION

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